508250163 11/28/2023

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TONY M. BREWER	02/02/2021

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 S. FEDERAL WAY	
City:	BOISE	
State/Country:	IDAHO	
Postal Code:	83716	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18101715

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NAME OF SUBMITTER:	NANCY R. GAMBURD	
SIGNATURE:	/Nancy R. Gamburd/	
DATE SIGNED:	11/28/2023	

Total Attachments: 2

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PATENT 508250163 REEL: 065683 FRAME: 0990

ASSIGNMENT AND AGREEMENT

For value received, I, **Tony M. Brewer** of the City of Plano in the State of Texas, hereby sell, assign and transfer to **Micron Technology, Inc.**, a Delaware corporation having an office at 8000 S. Federal Way, Boise, Idaho 83716 USA, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America and throughout the world, in, to and under certain inventions, whether claimed or unclaimed, related to:

System Having a Hybrid Threading Processor, a Hybrid Threading Fabric Having Configurable Computing Elements, and a Hybrid Interconnection Network described and claimed in an application for Letters Patent of the United States executed by me and filed on October 31, 2018 as U.S. Patent Application No. 16/176,434;

System Having a Hybrid Threading Processor, a Hybrid Threading Fabric Having Configurable Computing Elements, and a Hybrid Interconnection Network described and claimed in an application for Letters Patent of the United States executed by me and filed on October 31, 2018 as International PCT Patent Application No. PCT/US2018/058539;

System Having a Hybrid Threading Processor, a Hybrid Threading Fabric Having Configurable Computing Elements, and a Hybrid Interconnection Network described and claimed in an application for Letters Patent of the United States executed by me and filed on October 31, 2017 as U.S. Provisional Patent Application No. 62/579,749;

and all provisional, nonprovisional, divisional, continuation and continuation-in-part applications thereof or associated therewith, all reissues, reexaminations and extensions thereof, and all rights of priority arising from and the right to claim priority to said applications, and all the rights and privileges in said applications and under any and all patents, patent applications, patent rights, and inventor's certificates thereof that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc., the entire right, title and interest in and to said inventions and all patents, patent applications, patent rights, and inventor's certificates thereof for all countries foreign to the United States and for all other authorities, organizations or entities, including all rights of priority arising from the applications aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions; and with all of these rights, title and interest to be held and enjoyed by Micron Technology, Inc. as fully and completely as the same would have been held by me had this assignment not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the application, patents, utility models, or other similar rights resulting therefrom.

> PATENT REEL: 065683 FRAME: 0991

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in the United States and any and all countries foreign to the United States and all other authorities, organizations or entities, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology. Inc. in the United States and in all countries and all other authorities, organizations or entities foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, testify, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection, including but not limited to any supplemental examination, derivation proceedings, opposition, post grant review, reissue, reexamination, inter partes review, extension thereof, or litigation related thereto, including for protecting the validity of or protecting title to title to said inventions, and further agree not to challenge or participate in any challenge to the assigned inventions, or any patent application or patent thereon, whether by litigation, post grant review, inter partes review, reexamination, or otherwise.

The undersigned hereby grants Micron Technology, Inc., and/or any person authorized thereby, the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment, including without limitation the Application Number and filing date.

Tony M. Brewer

Date: Feb 2, 2021

Micron Technology, Inc. 8000 S. Federal Way Boise, Idaho 83716 USA

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